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The marking on this product doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2011/65/EU for RoHS compliant.



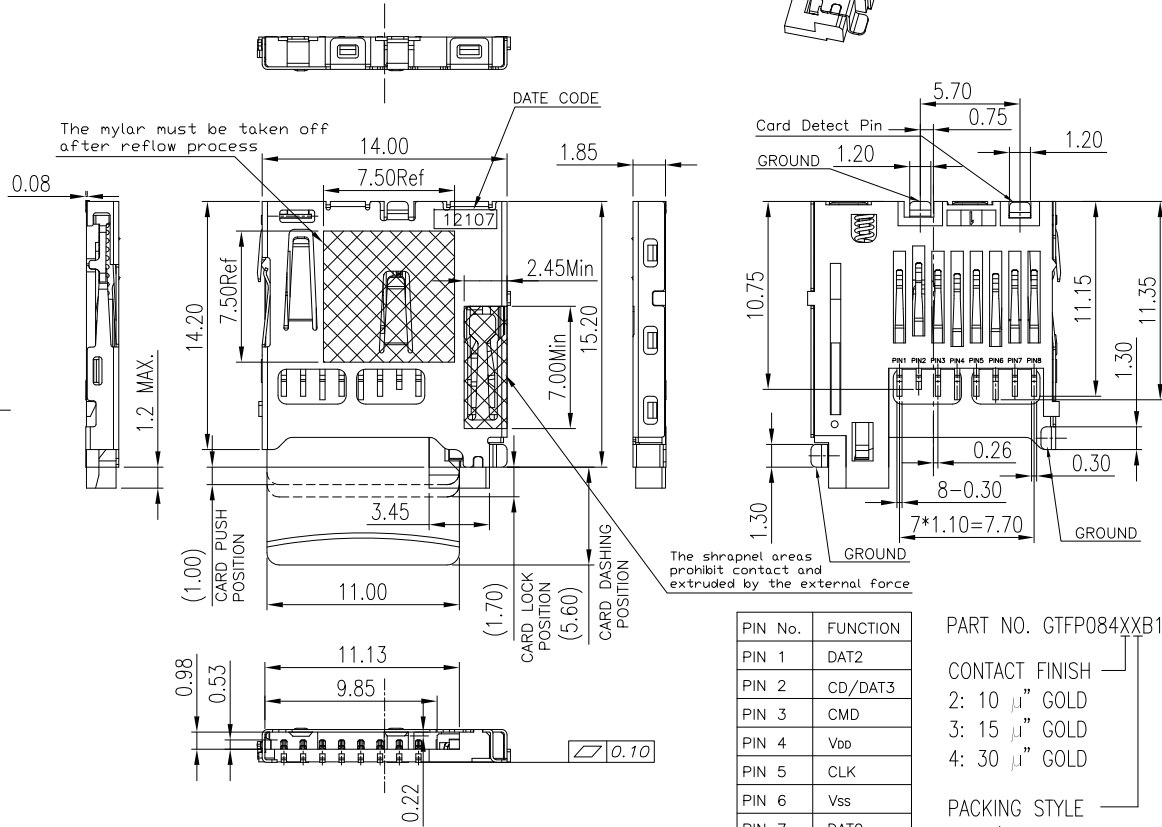
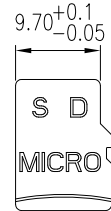
ORIGINAL



REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A	NE-16112	APPROVED REVISION	05/12/2016	Arron Lin

NOTES:

- INSULATOR: HIGH TEMPERATURE THERMOPLASTIC, LCP, UL 94V-0, COLOR- BLACK.
- CONTACT: COPPER ALLOY, SELECTIVE GOLD PLATING ON CONTACT AREA, MATTE TIN PLATING 100u" ON SOLDERING AREA.
- SHELL: STEEL (SUS 301), NI PLATING 50u" ON SOLDERING AREA.
- THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS MATERIALS PER DIRECTIVE 2011/65/EU FOR RoHS.
- RECOMMENDED SD CARD WIDTH IS DIM 9.70^{+0.1}_{-0.05} FOR TEST.
- PRODUCT SPECIFICATION REFER TO : PS-7500.

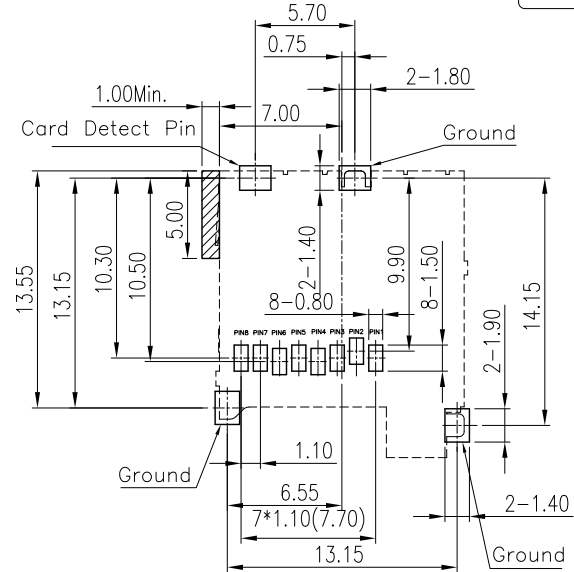


PIN No.	FUNCTION
PIN 1	DAT2
PIN 2	CD/DAT3
PIN 3	CMD
PIN 4	Vdd
PIN 5	CLK
PIN 6	Vss
PIN 7	DAT0
PIN 8	DAT1

PART NO. GTFP084XXB1E9

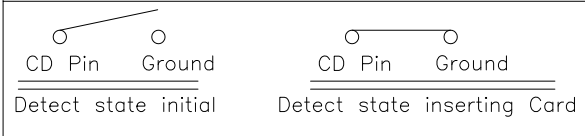
CONTACT FINISH
 2: 10 μ" GOLD
 3: 15 μ" GOLD
 4: 30 μ" GOLD

PACKING STYLE
 1: W/O MYLAR T&R
 2: W/ MYLAR T&R



RECOMMENDED SOLDER PAD AREA
 DEVICE KEEP OUT AREA

RECOMMENDED PCB LAYOUT
 (ALL TOLERANCE ARE ±0.05mm)
 TOP VIEW



TOLERANCE	APPROVALS	DATE
X.	DRAWN Debby Hung	05/12/2016
X.X ±0.30	CHECKED Roger Tsai	05/12/2016
X.XX ±0.20	APPROVED Arron Lin	05/12/2016
X.XXX ±0.10	DWG TYPE CUST DWG	PROJECT CODE OTHER
ANGULAR ±1°	UNLESS OTHERWISE SPECIFIED	

TITLE		
MICRO SD NORMAL OPEN TYPE (HEIGHT IS 1.85 MM) (NF 30gf MIN.)		
UNIT mm	SIZE A3	
SCALE NA	SHEET 1 OF 2	

Amphenol® Amphenol Corporation Amphenol Taiwan Corporation		PART No.	GTFP084XXB1E9
		DWG No.	GTFP084XXB1E9
REV.	A		

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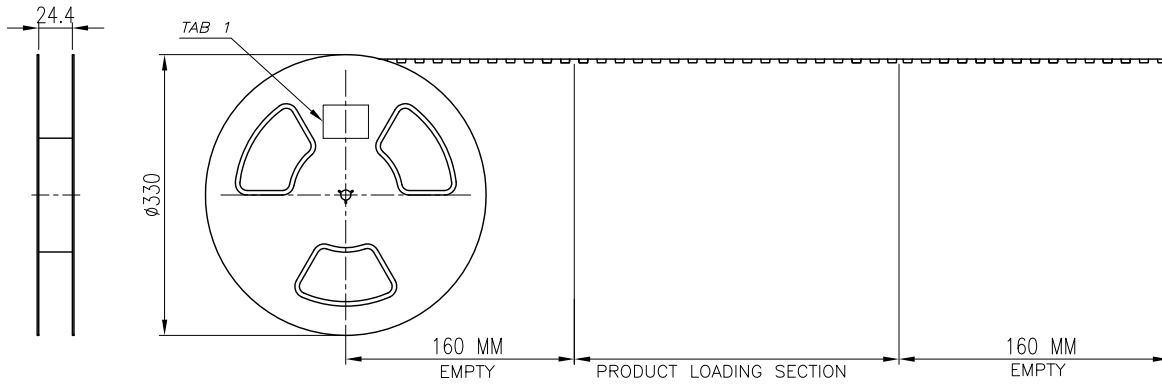
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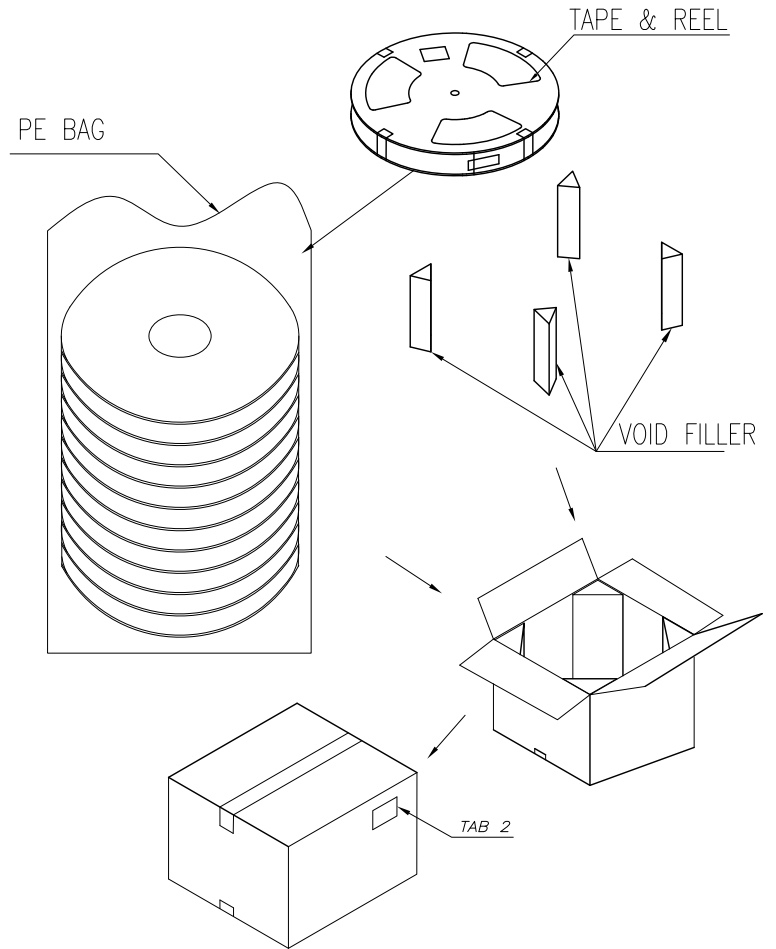
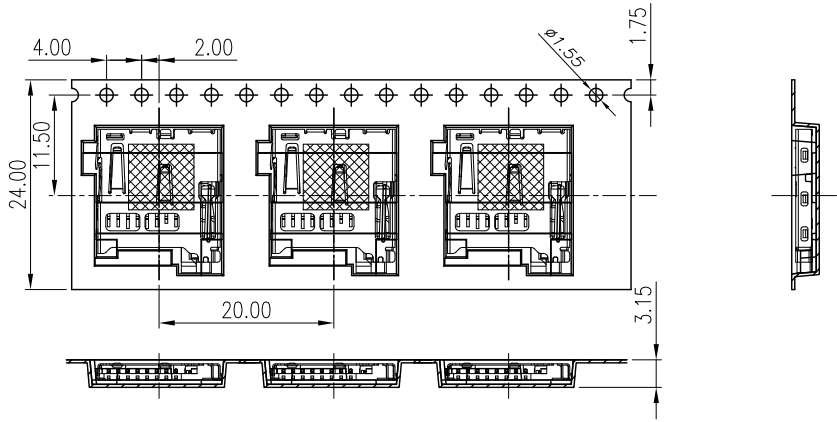
ORIGINAL



REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A	NE-16112	APPROVED REVISION	05/12/2016	Arron Lin



USER DIRECTION OF UNREELING →



PACKAGING BY TAPE&REEL	5.5	2.18	1000	5	5000	GTFP084XXB1EU
	G/W KG	N/W KG	PCS/ REEL	REELS/ CARTON	QUANTITY (PCS)	PART NUMBER

TOLERANCE	APPROVALS	DATE	TITLE	UNIT	SIZE	PART No.
X. ±0.30	DRAWN Debby Hung	05/12/2016	MICRO SD NORMAL OPEN TYPE (HEIGHT IS 1.85 MM) (NF 30gf MIN.)	mm	A3	GTFP084XXB1EU
X.X ±0.20	CHECKED Roger Tsai	05/12/2016				
X.XX ±0.10	APPROVED Arron Lin	05/12/2016		SCALE NA	SHEET 2 OF 2	DWG No. GTFP084XXB1EU
ANGULAR ±1°	DWG TYPE CUST DWG	PROJECT CODE OTHER		REV. A		
UNLESS OTHERWISE SPECIFIED						

